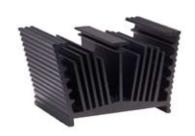
VX Series

Heat Sinks For TGHE Series and SOT-227 Devices



Ohmite introduces the VX series heat sinks for the Ohmite TGHE series and SOT-227 devices. This powerful heat sink has a unique profile that allows thru-hole soldering onto PCBs, panel mounting, or chassis mounting with fasteners. The VX series is an ideal heat sink that is designed for large power yet provides a light weight package and works with forced convection cooling.





SERIES SPECIFICATIONS

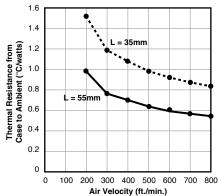
Heatsink Part Number	Compatible parts/devices	Surface Area (in² / mm²)	Weight (oz / g)	Length L (in. / mm)	Spacing S (in. / mm)	Thread
VXA-35-101E VXV-35-101E*	TGHE	38 / 24,638	1.4 / 39	1.38 / 35	1.10 / 28	МЗ
VXA-55-101E VXV-55-101E*	SOT-227	60 / 38,717	2.2 / 62	2.17 / 55	1.18 / 30	M3.5

^{*} Note: Anodized parts are standard; degreased available on request.

CHARACTERISTICS

Fastener	M3.5 Screw	
Thermal Interface Material	Use as needed. Ohmite TGH-TP1 for SOT-227 devices	
Material	AL 6063-T5	
Surface Finish	Black anodized or degreased	
Thermal Conductivity	209 W/m-K	

Thermal Performance



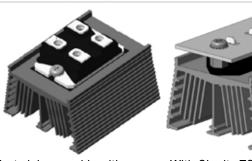
47°C 58°C 63°C 69°C

- Power dissipation is 100W, single device
- Heat load area 17 x 28mm metal tab

Max. case temp. on SOT-227 (hot spot) is 69° C @ 5.08m/s (1000 fpm) ducted

• Ducted air flow

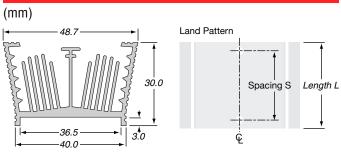
PCB Mounting Examples



Heat sink assembly with a resistor and thermal interface material fastened with two M3.5 screws.

With Ohmite TGHE resistor

DIMENSIONS



HOW TO ORDER



Mouser Electronics

Authorized Distributor

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Ohmite: